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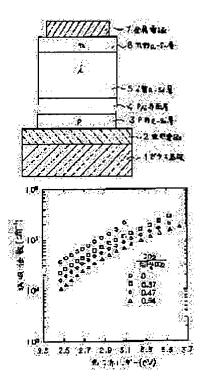
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(54) FORMATION OF SILICON OXIDE SEMICONDUCTOR FILM

(57)Abstract:

PURPOSE: To industrially form a silicon oxide semiconductor film having a low light absorption coefficient and high photoconductivity by resolving a gaseous raw material which contains at least SiH4, CO2, and H2 in a state where CO2/(SiH4+CO2) becomes a specific value. CONSTITUTION: In the method which is used for forming an SiO semiconductor film composed of a-SiO2 containing a microcrystalline layer of Si, the SiO semiconductor film is formed by resolving a gaseous raw material which contains at least SiH4, CO2, and H2 in a state where CO2/ (SiH4+CO2) becomes ≤0.6. At the time of decomposing the mixed gas, it is effective to generate glow discharge in the gas at a high-frequency power density of ≥40mW/cm2. The formed SiO semiconductor film has a absorption coefficient ≤106cm-1 against light having a wavelength of ≥340nm and photoconductivity of ≥10-6S/cm. In addition, it is effective, to use a p-type a-SiO layer 3 or n-type a-Si layer 6 obtained by mixing a doping gas with the gaseous raw material as the window layer of a solar battery.



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